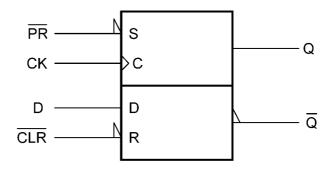


### 5. IEC Logic Symbol



#### 6. Truth Table

	Inp	uts		Out	puts	Function
CLR	PR	D	СК	Q	Q	Function
L	Н	Х	Х	L	Н	Clear
Н	L	Х	Х	Н	L	Preset
L	L	Х	Х	Н	Н	_
Н	Н	L		L	Н	_
Н	Н	Н		Н	L	_
Н	Н	Х		Qn	Qn	No Change

X: Don't care

### 7. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage	$V_{IN}$		-0.5 to 7.0	
DC output voltage	$V_{OUT}$		-0.5 to V <sub>CC</sub> + 0.5	
Input diode current	I <sub>IK</sub>		-20	mA
Output diode current	l <sub>ok</sub>	(Note 1)	±20	
DC output current	l <sub>out</sub>		±25	
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±50	
Power dissipation	P <sub>D</sub>		300	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:  $V_{OUT} < GND$ ,  $V_{OUT} > V_{CC}$ 



### 8. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	2.0 to 5.5	V
Input voltage	V <sub>IN</sub>		_	0 to 5.5	
Output voltage	V <sub>OUT</sub>		_	0 to V <sub>CC</sub>	
Operating temperature	T <sub>opr</sub>	(Note 1)		-40 to 125	°C
		(Note 2)	_	-40 to 85	
Input rise and fall time	dt/dv		$V_{CC} = 3.3 \pm 0.3 \text{ V}$	0 to 100	ns/V
			$V_{CC} = 5.0 \pm 0.5 \text{ V}$	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either  $V_{\mbox{\footnotesize{CC}}}$  or GND.

Note 1: For devices with the ordering part number ending in J(CT.

Note 2: For devices except those with the ordering part number ending in J(CT.

### 9. Electrical Characteristics

## 9.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	Test Condition		Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.5	_	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0	_		0.5	V
				3.0 to 5.5	_	_	$V_{CC} \times 0.3$	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IL} \text{ or } V_{IH}$	I <sub>OH</sub> = -50 μA	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I <sub>OH</sub> = -4 mA	3.0	2.58	_	_	
			I <sub>OH</sub> = -8 mA	4.5	3.94	_	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IL}$ or $V_{IH}$	I <sub>OL</sub> = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	
			I <sub>OL</sub> = 8 mA	4.5			0.36	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5			±0.1	μА
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		5.5	_	_	2.0	μΑ



# 9.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.5	_	V
				3.0 to 5.5	VCC × 0.7	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0	_	0.5	V
				3.0 to 5.5	_	VCC × 0.3	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IL}$ or $V_{IH}$	I <sub>OH</sub> = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.48	_	
			$I_{OH}$ = -8 mA	4.5	3.80	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	I <sub>OL</sub> = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	
				4.5	_	0.1	
			I <sub>OL</sub> = 4 mA	3.0	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5		0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	±1.0	μΑ
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		5.5	_	20.0	μΑ

## 9.3. DC Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C)

Characteristics	Symbol	Test Con	Test Condition			Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.5	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0		0.5	٧
				3.0 to 5.5		$V_{CC} \times 0.3$	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IL}$ or $V_{IH}$	I <sub>OH</sub> = -50 μA	2.0	1.9	_	٧
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.40	_	
			$I_{OH}$ = -8 mA	4.5	3.70	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	I <sub>OL</sub> = 50 μA	2.0		0.1	V
				3.0		0.1	
				4.5	_	0.1	
			$I_{OL} = 4 \text{ mA}$	3.0	_	0.55	
			I <sub>OL</sub> = 8 mA	4.5	_	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5		±2.0	μΑ
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	40.0	μΑ

Note: For devices with the ordering part number ending in J(CT.

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### 9.4. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width (CK)	$t_{W(L)}, t_{W(H)}$	_	$3.3 \pm 0.3$	6.0	ns
			5.0 ± 0.5	5.0	
Minimum pulse width	t <sub>W(L)</sub>	_	$3.3 \pm 0.3$	6.0	ns
(CLR, PR)			$5.0 \pm 0.5$	5.0	
Minimum setup time	ts	_	$3.3\pm0.3$	6.0	ns
			5.0 ± 0.5	5.0	
Minimum hold time	t <sub>h</sub>	_	$3.3\pm0.3$	0.5	ns
			5.0 ± 0.5	0.5	
Minimum removal time	t <sub>rem</sub>	_	$3.3\pm0.3$	5.0	ns
(CLR, PR)			5.0 ± 0.5	3.0	

# 9.5. Timing Requirements (Unless otherwise specified, $T_a$ = -40 to 85 °C, Input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width (CK)	$t_{W(L)}, t_{W(H)}$	_	$3.3 \pm 0.3$	7.0	ns
			$5.0 \pm 0.5$	5.0	
Minimum pulse width	t <sub>W(L)</sub>	_	$3.3 \pm 0.3$	7.0	ns
(CLR, PR)			$5.0 \pm 0.5$	5.0	
Minimum setup time	t <sub>s</sub>	_	$3.3 \pm 0.3$	7.0	ns
			$5.0 \pm 0.5$	5.0	
Minimum hold time	t <sub>h</sub>	_	$3.3 \pm 0.3$	0.5	ns
			5.0 ± 0.5	0.5	
Minimum removal time	t <sub>rem</sub>	_	$3.3 \pm 0.3$	5.0	ns
(CLR, PR)			$5.0 \pm 0.5$	3.0	

# 9.6. Timing Requirements (Note) (Unless otherwise specified, $T_a$ = -40 to 125 °C, Input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width (CK)	$t_{W(L)}, t_{W(H)}$	_	$3.3 \pm 0.3$	7.0	ns
			$5.0 \pm 0.5$	5.0	
Minimum pulse width	t <sub>W(L)</sub>	_	$3.3 \pm 0.3$	7.0	ns
(CLR, PR)			$5.0 \pm 0.5$	5.0	
Minimum setup time	t <sub>s</sub>	_	$3.3 \pm 0.3$	8.0	ns
			$5.0 \pm 0.5$	5.5	
Minimum hold time	t <sub>h</sub>	_	$3.3 \pm 0.3$	0.5	ns
			$5.0 \pm 0.5$	0.5	
Minimum removal time	t <sub>rem</sub>	_	$3.3 \pm 0.3$	5.0	ns
(CLR, PR)			$5.0 \pm 0.5$	3.0	

Note: For devices with the ordering part number ending in J(CT.



### 9.7. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	$3.3 \pm 0.3$	15	_	6.7	11.9	ns
(CK-Q,Q)					50	_	9.2	15.4	
				5.0 ± 0.5	15	_	4.6	7.3	
					50	_	6.1	9.3	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	$3.3\pm0.3$	15	_	7.6	12.3	ns
(CLR,PR-Q,Q)					50	_	10.1	15.8	
				$5.0 \pm 0.5$	15	_	4.8	7.7	
					50	_	6.3	9.7	
Maximum clock frequency	f <sub>MAX</sub>		_	$3.3\pm0.3$	15	80	125	_	MHz
					50	50	75	_	
				5.0 ± 0.5	15	130	170	_	
					50	90	115	_	
Input capacitance	C <sub>IN</sub>		_			_	4	10	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 1)	_			_	22		pF

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

# 9.8. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	$3.3 \pm 0.3$	15	1.0	14.0	ns
(CK-Q,Q)				50	1.0	17.5	
			$5.0 \pm 0.5$	15	1.0	8.5	
				50	1.0	10.5	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	$3.3\pm0.3$	15	1.0	14.5	ns
$(\overline{CLR},\overline{PR}-Q,\overline{Q})$				50	1.0	18.0	
			$5.0 \pm 0.5$	15	1.0	9.0	
				50	1.0	11.0	
Maximum clock frequency	f <sub>MAX</sub>	_	$3.3\pm0.3$	15	70	_	MHz
				50	45	_	
			5.0 ± 0.5	15	110	_	
				50	75		
Input capacitance	C <sub>IN</sub>	_			_	10	pF

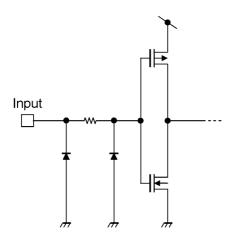


# 9.9. AC Characteristics (Note) (Unless otherwise specified, $T_a$ = -40 to 125 °C, Input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	$3.3\pm0.3$	15	1.0	16.0	ns
(CK-Q,Q)				50	1.0	19.5	
			5.0 ± 0.5	15	1.0	10.0	
				50	1.0	12.0	
Propagation delay time (CLR,PR-Q,Q)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	3.3 ± 0.3	15	1.0	16.5	ns
				50	1.0	20.0	
			5.0 ± 0.5	15	1.0	10.5	
				50	1.0	12.5	
Maximum clock frequency	f <sub>MAX</sub>	_	$3.3 \pm 0.3$	15	60	_	MHz
				50	40	_	
			5.0 ± 0.5	15	100	_	
				50	70	_	
Input capacitance	C <sub>IN</sub>	_	•			10	pF

Note: For devices with the ordering part number ending in J(CT.

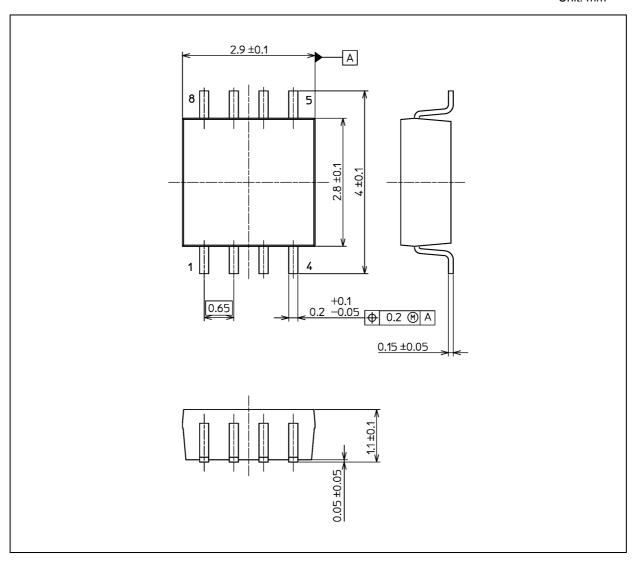
### 9.10. Input Equivalent Circuit





### **Package Dimensions**

Unit: mm



Weight: 21 mg (typ.)

	Package Name(s)	
JEDEC: SOT-505		
Nickname: SM8		

Rev.4.0



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